



# 12mm GPS/GLONASS/GALILEO SMT Mount Ceramic Patch Antenna

Part No: SGGP.12.4.A.02

#### **Features:**

1575.42 /1602 MHz GPS/GLONASS Antenna

2.67 dBi Peak Gain for GPS/GALILEO Band

2.94 dBi Peak Gain for GLONASS Band

12 x 12 x 4mm dimension

SMT direct mount ceramic patch antenna

Automotive TS16949 Production and Quality Approved

RoHS Compliant



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### 1. Introduction



The SGGP.12.4.A.02 is a ceramic GPS/GLONASS/GALILEO passive patch antenna with low-profile thickness of 4mm. It is designed for applications in navigation devices, vehicle tracking/fleet management systems, and telematics devices. Typical applicable industries are transportation, defense, marine, agriculture, and navigation.

The antenna has been tuned on a  $50 \times 50$  mm ground plane, working at 1575.42MHz and 1602MHz, with a 2.67 dBi gain and 2.94 dBi gain, respectively. The ceramic patch is mounted via SMT process. It is manufactured and tested in a TS16949 first tier automotive approved facility.

For customer specific device environments, custom tuned patch antennas are highly recommended, subject to potential NRE and MOQ. Contact your regional Taoglas sales office for details.



## Specification

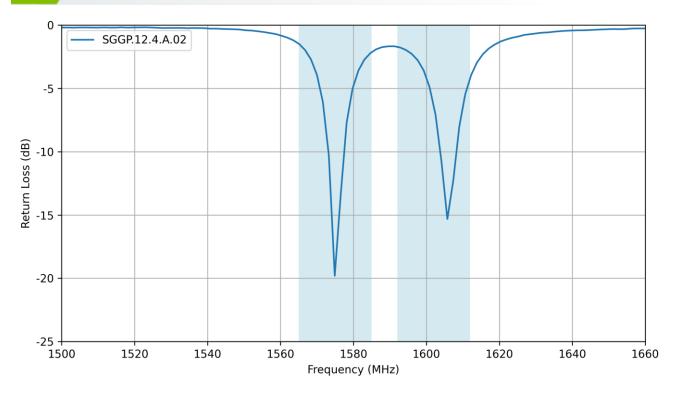
		GNSS Frequ	ency Bands		
GPS	L1 1575.42 MHz	L2 1227.6 MHz	L5 1176.45 MHz		
	-				
GLONASS	G1 1602 MHz	G2 1248 MHz	G3 1207 MHz		
	-				
Galileo	E1 1575.24 MHz	E5a 1176.45 MHz	E5b 1201.5 MHz	E6 1278.75 MHz	
	-				
BeiDou	B1C 1575.42 MHz	B1I 1561 MHz	B2a 1176.45 MHz	B2b 1207.14 MHz	B3 1268.52 MHz
	•				
QZSS (Regional)	L1 1575.42 MHz	L2C 1227.6 MHz	L5 1176.45 MHz	L6 1278.75e6	
	•				
IRNSS (Regional)	L5 1176.45 MHz				
SBAS	L1/E1/B1 1575.42 MHz	L5/B2a/E5a 1176.45 MHz	G1 1602 MHz	G2 1248 MHz	G3 1207 MHz
	•		•		

	GNSS Electrical	
Frequency (MHz)	1575.42	1602
VSWR (max.)	2.0:1	2.0:1
Passive Antenna Efficiency (%) (Without cable loss)	65.69	43.15
Passive Antenna Gain at Zenith (dBi) (Without cable loss)	2.96	1.77
Polarization	RHO	CP
Impedance	50	Ω
	Mechanical	
Ceramic Dimension (mm)	12 x 12	x 4
Weight (g)	3.3	
	Environmental	
Operation Temperature	-40°C to	85°C
Humidity	Non-condensing	65°C 95% RH
Moisture Sensitivity Level (MSL)	3 (168 Ho	ours)

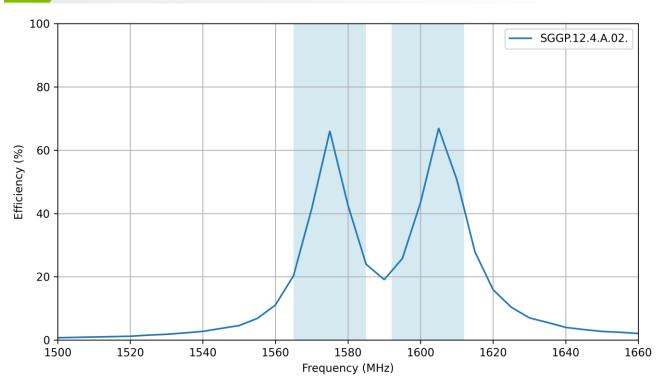


## 3. Antenna Characteristics

### 3.1 Return Loss

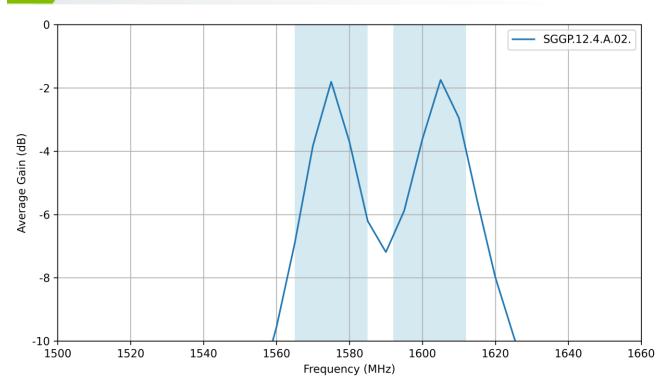


### 3.2 Efficiency

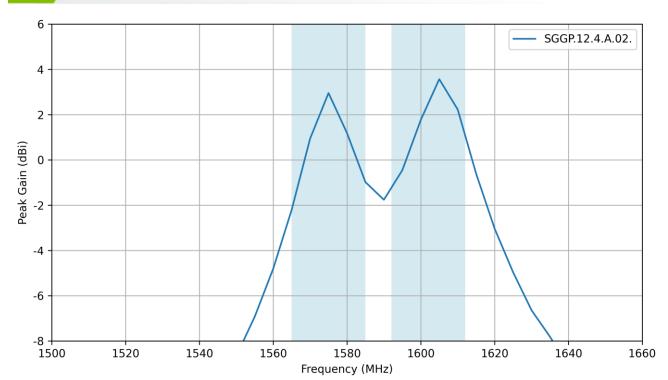




### 3.3 Average Gain



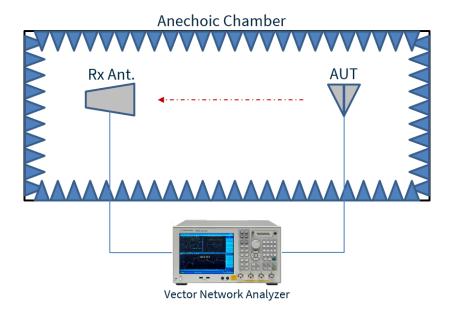
### 3.4 Peak Gain

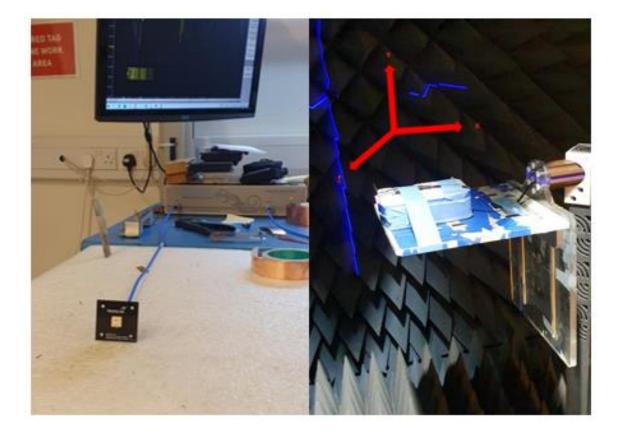




## 4. Radiation Patterns

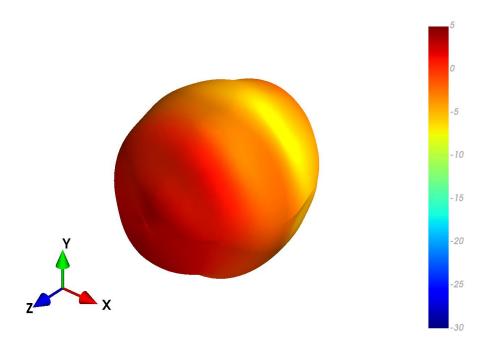
### 4.1 Test Setup

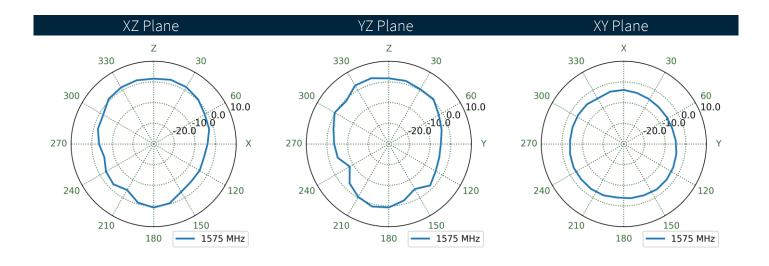






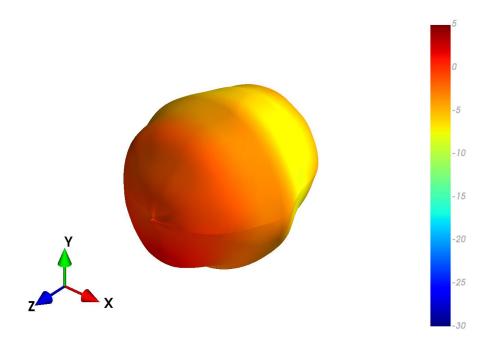
### 4.2 SGGP.12.4.A.02. Patterns at 1575 MHz

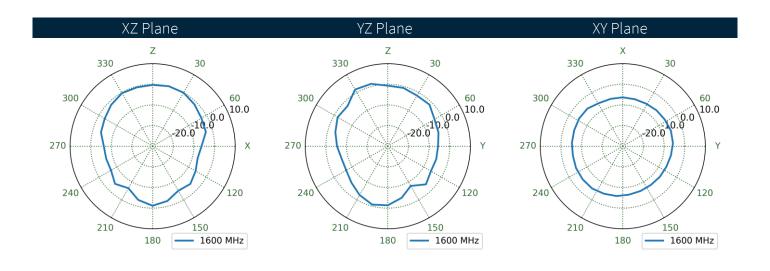






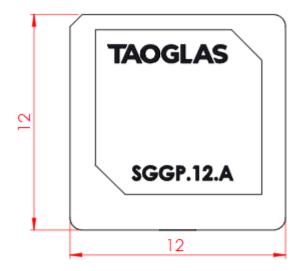
### 3 SGGP.12.4.A.02. Patterns at 1602 MHz

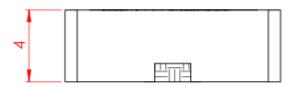


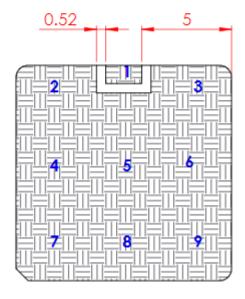


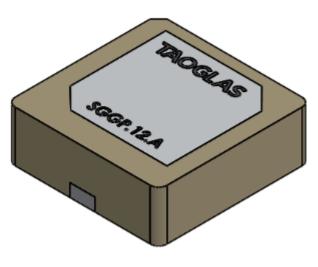


## Mechanical Drawing





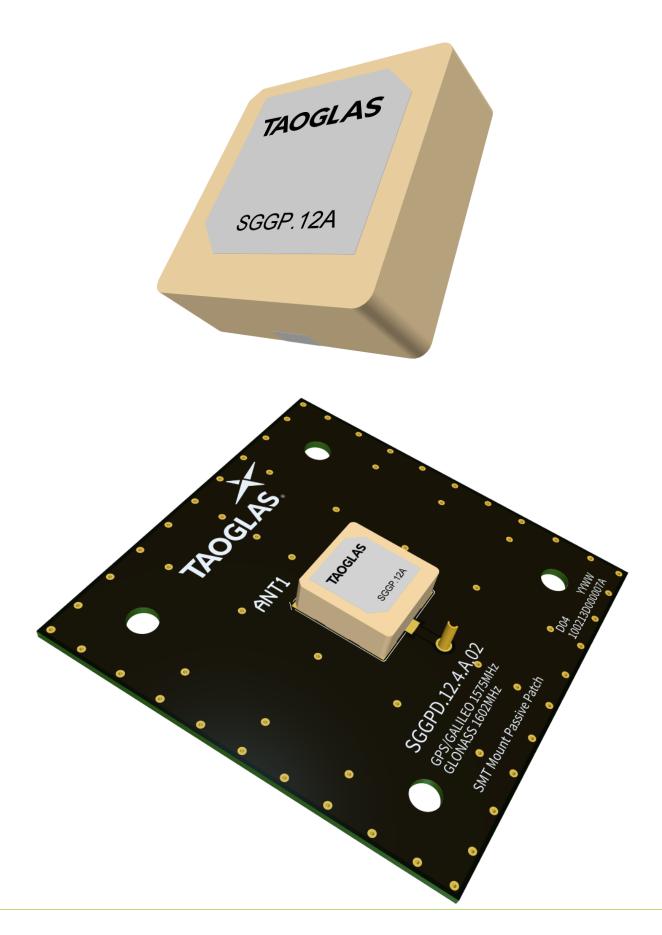




MODEL VIEW



## . Antenna Integration Guide

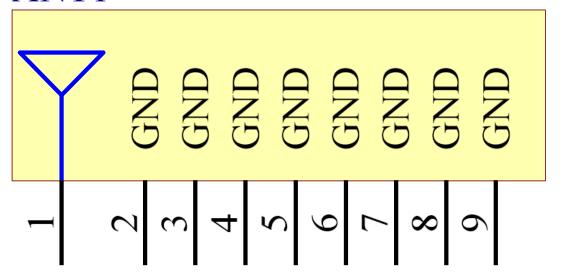




### 6.1 Schematic and Symbol Definition

The circuit symbol for the antenna is shown below. The antenna has 9 pins as indicated below.

## SGGP.12.4.A.02 ANT1



Pin	Description
1	RF Feed
2, 3, 4, 5, 6, 7, 8, 9	Ground



#### 6.2 Antenna Integration

The antenna should be placed at the center of the ground plane with a length and width of 50mm. Maintaining a square symmetric ground plane shape and symmetric environment around the antenna is critical to maintaining the excellent axial ratio and phase center performance shown in this datasheet.



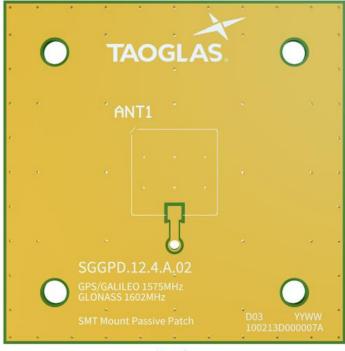


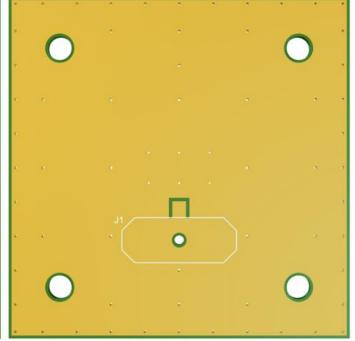
Top Side w/ Solder Mask

Top Side w/o Solder Mask

### 6.3 PCB Layout

The footprint and clearance on the PCB must comply with the antenna specification. The PCB layout shown in the diagram below demonstrates the antenna footprint.

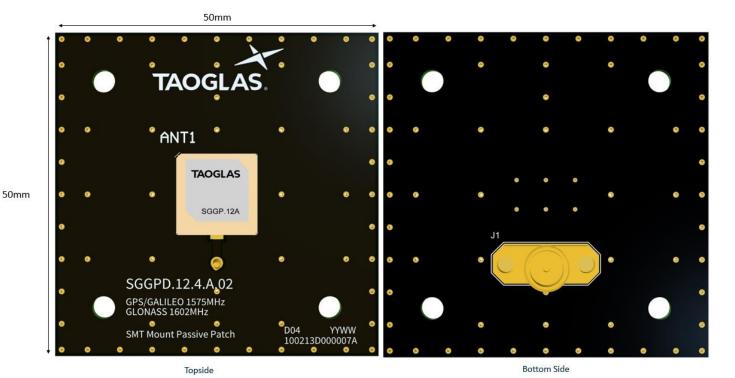




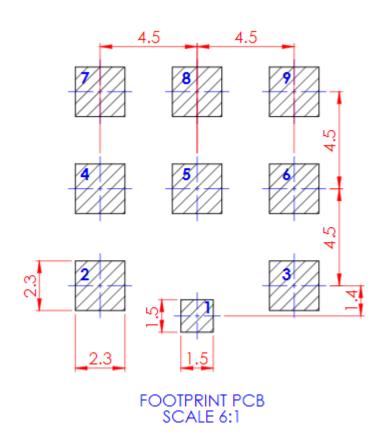
Topside Bottom Side



### 6.4 Evaluation Board



6.5 Footprint



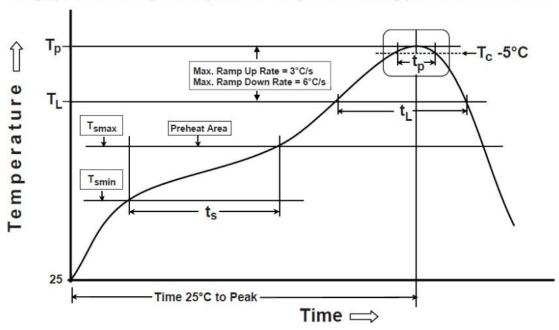


### 7. Solder Reflow Profile

SGGP.25A can be assembled following Pb-free assembly. According to the Standard IPC/JEDEC J-STD-020C, the temperature profile suggested is as follow:

Phase	Profile Features	Pb-Free Assembly (SnAgCu)
PREHEAT	Temperature Min(Tsmin) Temperature Max(Tsmax) Time(ts) from (Tsmin to Tsmax)	150°C 200°C 60-120 seconds
RAMP-UP	Avg. Ramp-up Rate (Tsmax to TP)	3°C/second(max)
REFLOW	Temperature(TL) Total Time above TL (tL)	217°C 30-100 seconds
PEAK	Temperature(TP) Time(tp)	260°C 2-5 seconds
RAMP-DOWN	Rate	3°C/second(max)
	Time from 25°C to Peak Temperature	8 minutes max.
	Composition of solder paste	96.5Sn/3Ag/0.5Cu
	Solder Paste Model	SHENMAO PF606-P26

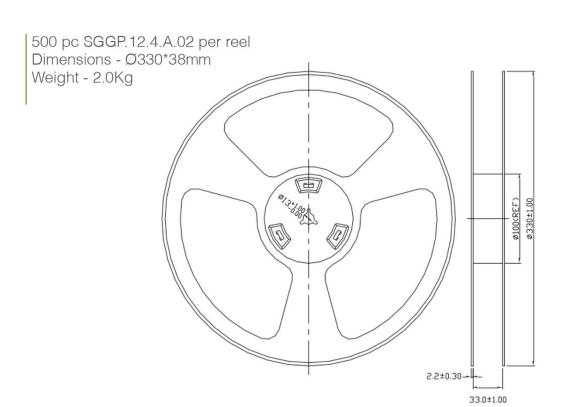
#### The graphic shows temperature profile for component assembly process in reflow ovens

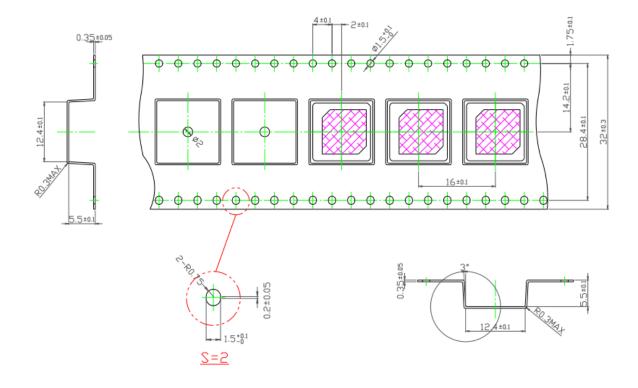


Soldering Iron condition: Soldering iron temperature 270°C±10°C.

Apply preheating at 120°C for 2-3 minutes. Finish soldering for each terminal within 3 seconds, if soldering iron temperature over270°C±10°C or 3 seconds, it will make cause component surface peeling or damage.

8.







#### Changelog for the datasheet

#### SPE-15-8-034- SGGP.12.4.A.02

Revision: C (Current	Version)
Date:	2023-04-11
Changes:	Updated environmental specifications
Changes Made by:	Cesar Sousa

#### **Previous Revisions**

Revision: B	
Date:	2022-10-24
Changes:	Full Datasheet Update
Changes Made by:	Evan Murphy
Revision: A (Origina	al First Release)
Date:	·
Notes:	
Author:	Technical Writer